	Aaterial Compositio Copyright 2005. IPC, Bannockburn, Illir oth international and Pan-American copyri	n Declaration with lowe		declaration of	encompasses		terials for wh	e: if the item is an assembly nich the manufacturer has this declaration.			
	PC Web Site for Information on II ttp://www.ipc.org/IPC-175x	PC-1752 Standard	Form Type * Distribute	-		aration Class * s 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa					
Supplier Information											
Company Name *	Company Unique ID	Unique ID Authority	Response Date	e *	Respon	se Document ID					
Anaren Microwave			2020-02-04								
Contact Name *	Title - Contact	Phone - Contact *	Email - Contac	t *							
Herbert Jones	Project Engineer	315-233-5510	herbert.jones@	ettm.com	Du	Duplicate Contact -> Authorized Representative					
Authorized Representative	* Title - Representative	Phone - Representative *	Email - Repres	Email - Representative * Suppli			plier Comments or URL for Additional Information				
Herbert Jones	Project Engineer	315-233-5510	herbert.jones@	ettm.com							
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version M	anufacturing S	Site Weight *	UOM	Unit Type			
	XRA60CC30SES	Surface Mount Attenuator	2020-02-04	A Ea	ast Syracuse	0.14264	g	Each			
Alternate Recommendati	on			Alternate Ite	m Comments						
Manufacturing Process	Information										
Terminal Plating / Grid Array Ma	aterial Termina	I Base Alloy J-STD-020 MSL F	Rating Peak Proc	ess Body Te	mperature M	ax Time at Peak Ten	nperature Nu	mber of Reflow Cycles			
Matte Tin (Sn) - with Nick	el (Ni) barrier Other	1	-	26	0 C	<b>30</b> s	30 seconds 3				
Comments Compliant to RoHS 2 Direct	ctive 2011/65/EU of the Europe	an Parliament and of the Coun	ncil of 8 June 201	1 & Comm	ission Deleç	gated Directive 20	15/863/EU	of 31 March 2015.			

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent changes	Lock Supplier Fields			
<b>RoHS Material Con</b>	mposition Declarat	ion				Declaration Type *	Custom			
RoHS Directive 2002/95/ECRoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (1000 PPM) of homogeneous material for Cadmium										
RoHS 2 (Directive 2011/65/EU (DIBP).	& 2015/863/EU) Definition Add	dendum: Quantity limit of 0.1% by ma	ass (1000 PPM) in homog	eneous material for: Bis(2-ethy	ihexyl) phthalate (DEHP), Butyl	benzyl phthalate (BBP), Dibutyl phthala	ate (DBP), Diisobutyl phthalate			
date that Supplier completes the Supplier may have relied on in Supplier agrees that, at a mining	his form. Supplier acknowledge formation provided by others in mum, its suppliers have provide t to the identified part, the terms	es that Company will rely on this cert completing this form, and that Supp ed certifications regarding their contri and conditions of that agreement, ir	ification in determining the lier may not have indepen ibutions to the part, and th	e compliance of its products wit dently verified such information ose certifications are at least a	h European Union member stat n. However, in situations where s comprehensive as the certifica	ion is true and correct to the best of its k te laws that implement the RoHS Directi e Supplier has not independently verified ation in this paragraph. If the Company the sole and exclusive source of the Sup	ve. Company acknowledges that I information provided by others, and the Supplier enter into a			
RoHS Declaration *	1 - Item(s) does not contain	RoHS restricted substances per th	e definition above			Supplier Acceptance * Acce	pted			
Exemptions: If the declar above and choose all app		in RoHS restricted substance	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding respor	nse in the RoHS Declaration			
Declaration Signa	ture									
-	-	ields on all pages of this f and click on Submit Form				own. This will display the sig	nature area. Digitally sign			
Supplier Digital Signat	ture									

## Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem Name		Homogeneous Material	Weight	Unit of Measure			Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of Measure	Tolera	ance +	РРМ
+  -	XRA60CC30SES	+м-м	Part Marking Ink	0.00000	80	+C	-c	Supplier	Part Marking Ink	+S	-s	Titanium dioxide (TiO2)	13463-67-7		0.000007	a			857,10
			· ·····j ····		3		-	Supplier	Part Marking Ink			Silica amorphous (SiO2			0.000001	-			142,90
		+м-м	Protective Glaze	0 00267	5		_	Supplier	Protective Glaze			Boron Oxide (BO)	1303-86-2		0.000161	0			60,220
			FIOLECLIVE GIAZE	0.00207	y		_		Protective Glaze			Aluminum Oxide (Al2O3				-			
								Supplier							0.000048	-			18,068
							_	Supplier	Protective Glaze			Silicon Dioxide (SiO2)	14808-60-7		0.000048	g			18,068
						+C	-C	Supplier	Protective Glaze	+S	-S	*Proprietary Metal Com	Proprietary		0.000192	g			71,899
						+C	-C	Supplier	Protective Glaze	+S	-S	*Proprietary Blue Pigme	Proprietary		0.000384	g			143,79
						+C	-C	Supplier	Protective Glaze	+S	-S	Chromium(III) oxide (Cr	1308-38-9		0.000010	g			3,990.3
						+C	-C	Supplier	Protective Glaze	+S	-S	Cobalt (Co)	7440-48-4		0.000577	g			215,69
						+C	-C	Supplier	Protective Glaze	+S	-S	Molybdenum (Mo)	7439-98-7		0.000769	g			287,59
						+C	-C	Supplier	Protective Glaze	+S	-S	Zinc oxide (ZnO)	1314-13-2		0.000483	g			180,66
		+M -M	Thick Film Resis	0.00049	4g	+C	-C	Supplier	Thick Film Resistor	+S	-S	Boron Oxide (BO)	1303-86-2		0.000066	g			134,60
						+C	-C	Supplier	Thick Film Resistor	+S	-S	Magnesium Oxide (MgO	1309-48-4		0.000047	g			96,200
						+C	-C	Supplier	Thick Film Resistor	+S	-S	Aluminum Oxide (Al2O3	1344-28-1		0.000066	g			134,60
						+C	-C	Supplier	Thick Film Resistor	+S	-S	Silicon Dioxide (SiO2)	14808-60-7		0.000025	g			51,300
						+C	-C	Supplier	Thick Film Resistor	+S	-S	Ruthenium(IV) dioxide (	12036-10-1		0.000244	g			493,60
						+C	-C	Supplier	Thick Film Resistor	+S	-S	Zinc oxide (ZnO)	1314-13-2		0.000044	g			89,700
		+M -M	Conductor	0.00333	5g	+C	-C	Supplier	Conductor	+S	-S	Silver (Ag)	7440-22-4		0.003035	g			910,00
						+C	-C	Supplier	Conductor	+S	-S	Cobalt (Co)	7440-48-4		0.000050	g			15,000
						+C	-C	Supplier	Conductor	+S	-S	Titanium (Ti)	7440-32-6		0.000250	g			75,000
		+M -M	Substrate	0.13411	8g	+C	-C	Supplier	Substrate	+S	-S	Aluminum Nitride (ALN	24304-00-5		0.127412	g			950,00
						+C	-C	Supplier	Substrate	+S	-S	Yttrium (III) oxide (Y2O3	1314-36-9		0.006705	g			50,000
		+M -M	Nickel Plating	0.00153	g	+C	-C	A	Lead/Lead Compound	+S	-S	Lead	7439-92-1		0.00000	g			499.75

		+C -C B	Nickel (external applic	+S -S	Nickel	7440-02-0	0.001530g	,	999,50
+M -M Tin Plating	0.000477g	+C -C Supplier	Tin Plating	+S -S	Tin (Sn)	7440-31-5	0.000477g	1	1,000,0